













INA139, INA169 ZHCSFN5E - DECEMBER 2000 - REVISED DECEMBER 2015

# INA1x9 高侧测量分流监测计

### 特性

- 完整的单极高侧电流测量电路
- 宽电源和共模范围
- INA139: 2.7V 至 40V
- INA169: 2.7V 至 60V
- 独立电源和输入共模电压
- 单电阻增益设定
- 低静态电流: 60µA(典型值)
- 5 引脚小外形尺寸晶体管 (SOT)-23 封装

#### 应用 2

- 分流测量:
  - 汽车、电话、计算机
- 便携式和备用电池系统
- 电池充电器
- 电源管理
- 手机
- 精密电流源

### 3 说明

INA139 和 INA169 均为高侧单极分流监测计。此类器 件兼具宽输入共模电压范围、高速和低静态电流特性, 并且采用小型 SOT-23 封装,广泛适用于各类应用。

输入共模和电源电压相互独立, INA139 的电压范围为 2.7V 至 40V, INA169 的电压范围为 2.7V 至 60V。静 态电流仅为 60µA, 允许电源连接到电流测量分流器的 任一侧,同时误差非常小。

该器件可将一个差分输入电压转换为电流输出。此电流 使用外部负载电阻转换回电压, 该电阻可设置的增益范 围为 1 至 100 以上。尽管该电路专为分流测量而设 计,但同时也非常适用于创造性应用中的测量和电平 转换。

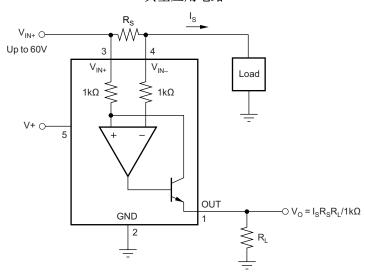
INA139 和 INA169 均采用 5 引脚 SOT-23 封装,额定 温度范围为 -40°C 至 85°C。

#### 器件信息(1)

	HH 11 1H 10.	
器件型号	封装	封装尺寸 (标称值)
INA139	SOT-23 (5)	2.00mm v 1.60mm
INA169	301-23 (5)	2.90mm x 1.60mm

(1) 要了解所有可用封装,请见数据表末尾的可订购产品附录。

### 典型应用电路





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# 4 修订历史记录

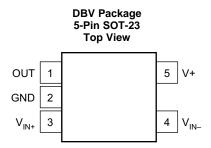
注: 之前版本的页码可能与当前版本有所不同。

### Changes from Revision D (November 2005) to Revision E

Page



# **5 Pin Configuration and Functions**



### **Pin Functions**

PIN		1/0	DESCRIPTION					
NAME	NO.	I/O	DESCRIPTION					
OUT	1	0	Output current					
GND	2	_	Ground					
VIN+	3	I	Positive input voltage					
VIN-	4	1	Negative input voltage					
V+	5	I	Power supply voltage					



# 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

			MIN	MAX	UNIT
\/.	Committee	INA139	-0.3	60	V
V+	Supply voltage	INA169	-0.3	75	V
	Analan innuta INIA420	Common mode <sup>(2)</sup>	-0.3	60	V
\	Analog inputs, INA139	Differential (V <sub>IN+</sub> ) – (V <sub>IN</sub> –)	-40	2	V
$V_{IN+}, V_{IN-}$	Analog inputs, INA169	Common mode <sup>(2)</sup>	-0.3	75	V
		Differential (V <sub>IN+</sub> ) – (V <sub>IN</sub> –)	-40	2	V
	Analog output, Out (2)		-0.3	40	V
	Input current into any pin			10	mA
	Operating temperature		-55	125	°C
TJ	Junction temperature			150	°C
T <sub>stg</sub>	Storage temperature		-65	125	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### 6.2 ESD Ratings

			VALUE	UNIT
		Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	±1000	
V <sub>(ESD)</sub>	Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	±500	V

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

	MIN	NOM	MAX	UNIT
INA139				
V+	2.7	5	40	V
Common mode voltage	2.7	12	40	V
INA169				
V+	2.7	5	60	V
Common mode voltage	2.7	12	60	V

### 6.4 Thermal Information

		INA1x9		
	THERMAL METRIC <sup>(1)</sup>	DBV (SOT-23)	UNIT	
		5 PINS		
$R_{\theta JA}$	Junction-to-ambient thermal resistance	168.3	°C/W	
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	73.8	°C/W	
$R_{\theta JB}$	Junction-to-board thermal resistance	28.1	°C/W	
ΨЈТ	Junction-to-top characterization parameter	2.5	°C/W	
ΨЈВ	Junction-to-board characterization parameter	27.6	°C/W	

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

<sup>(2)</sup> The input voltage at any pin may exceed the voltage shown if the current at that pin is limited to 10mA.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



### 6.5 Electrical Characteristics

All other characteristics at  $T_A = -40$  °C to 85 °C,  $V_+ = 5$  V,  $V_{IN+} = 12$  V, and  $R_{OUT} = 25$  k $\Omega$ , unless otherwise noted.

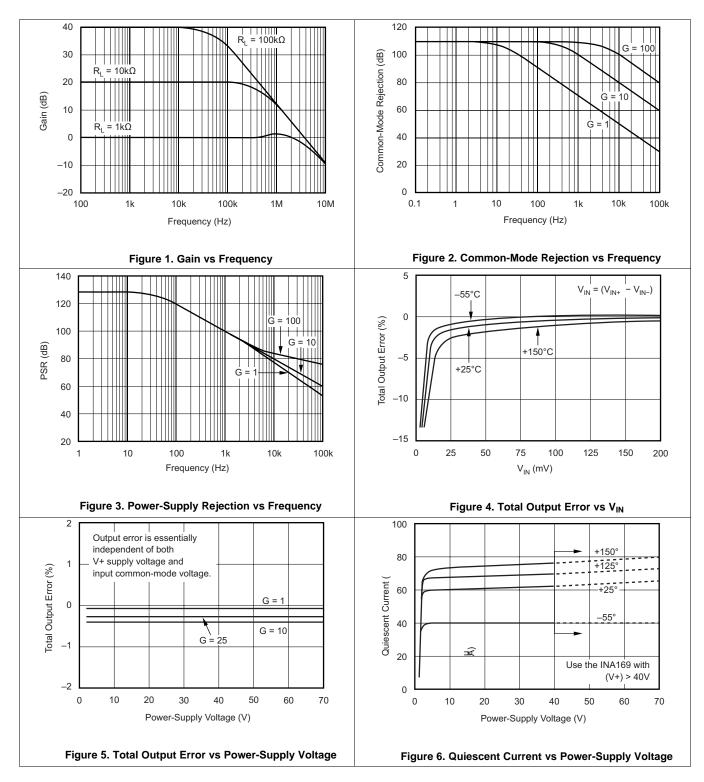
D.4	DAMETED	TEST SOMBITIONS		INA139N	A		INA169NA			
PARAMETER		TEST CONDITIONS	MIN TYP MAX		MAX	MIN TYP MAX			UNIT	
INPUT										
Full-Scale Sense	e Voltage	$V_{SENSE} = V_{IN+} - V_{IN-}$		100	500		100	500	mV	
Common-Mode	Input Range		2.7		40	2.7		60	٧	
Common-Mode	Rejection	$V_{\text{IN+}} = 2.7 \text{ V to } 40 \text{ V}, V_{\text{SENSE}} = 50 \\ \text{mV} \\ V_{\text{IN+}} = 2.7 \text{ V to } 60 \text{ V}, V_{\text{SENSE}} = 50 \\ \text{mV}$	100	115					dB	
Offset Voltage <sup>(1)</sup>	) RTI			±0.2	±1	100	120 ±0.2	±1	dB mV	
vs Temperature		T <sub>MIN</sub> to T <sub>MAX</sub>		1			1		μV/°C	
vo remperature		$V_{MIN} = 2.7 \text{ V to } 40 \text{ V}, V_{SENSE} = 50 \text{ mV}$		0.5	10		<u>'</u>		μν/ Ο	
vs Power Supply	y, V+	$V + = 2.7 \text{ V to } 40 \text{ V}, \text{ V}_{SENSE} = 50 \text{ mV}$		0.5	10		0.1	10	μV/V	
Input Bias Curre	ent	The second of th		10			10		μA	
OUTPUT										
		V <sub>SENSE</sub> = 10 mV - 150 mV	990	1000	1010	990	1000	1010	μA/V	
Transconductan	ce vs Temperature	V <sub>SENSE</sub> = 10 mV,		10			10		nA/°C	
Nonlinearity Erro	or	V <sub>SENSE</sub> = 10 mV to 150 mV		±0.01%	±0.1%		±0.01%	±0.1%		
Total Output Err	or	V <sub>SENSE</sub> = 100 mV		±0.5%	±2%		±0.5%	±2%		
Output Impedan	се			1    5			1    5		GΩ    pF	
V 1 0 1 1	Swing to Power Supply, V+			(V+) - 0.9	(V+) - 1.2		(V+) - 0.9	(V+) - 1.2	V	
Voltage Output	Swing to Common Mode, V <sub>CM</sub>			V <sub>CM</sub> - 0.6	V <sub>CM</sub> -1		V <sub>CM</sub> - 0.6	V <sub>CM</sub> - 1	V	
FREQUENCY R	ESPONSE									
B 1 1 1 1 1 1 1		$R_{OUT} = 10 \text{ k}\Omega$		440			440		kHz	
Bandwidth		$R_{OUT} = 20 \text{ k}\Omega$		220			220		kHz	
C-#1: Ti (0	40()	5-V Step, $R_{OUT}$ = 10 kΩ		2.5			2.5		μs	
Settling Time (0	. 1%)	5-V Step, $R_{OUT} = 20 \text{ k}\Omega$		5			5		μs	
NOISE										
Output-Current I	Noise Density			20			20		pA/√ <del>Hz</del>	
Total Output-Cu	rrent Noise	BW = 100 kHz		7			7		nA RMS	
POWER SUPPL	_Y									
Operating Rang	e, V+		2.7		40	2.7		60	٧	
Quiescent Current		$V_{SENSE} = 0$ , $I_O = 0$		60	125		60	125	μΑ	
TEMPERATURI	E RANGE									
Specification, $T_N$	<sub>MIN</sub> to T <sub>MAX</sub>		-40		85	-40		85	°C	
Operating			-55		125	<b>–</b> 55		125	°C	
Storage			-65		150	-65		150	°C	
Thermal Resista	ance, $\theta_{JA}$			200	T		200		°C/W	

<sup>(1)</sup> Defined as the amount of input voltage,  $V_{\text{SENSE}}$ , to drive the output to zero.

### TEXAS INSTRUMENTS

### 6.6 Typical Characteristics

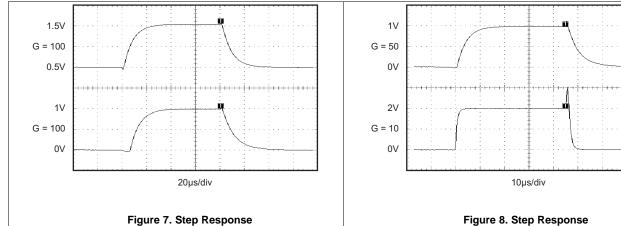
At  $T_A$  = 25°C, V+ = 5 V,  $V_{IN+}$  = 12 V, and  $R_L$  = 125 k $\Omega$ , unless otherwise noted.





# **Typical Characteristics (continued)**

At  $T_A$  = 25°C, V+ = 5 V,  $V_{IN+}$  = 12 V, and  $R_L$  = 125 k $\Omega$ , unless otherwise noted.



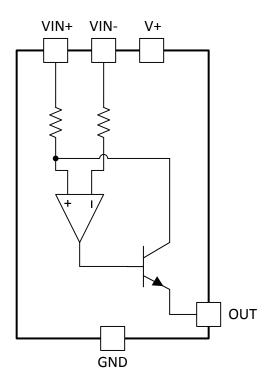


### 7 Detailed Description

#### 7.1 Overview

The INA139 and INA169 devices are comprised of a high voltage, precision operational amplifier, precision thin film resistors trimmed in production to an absolute tolerance and a low noise output transistor. The INA139 and INA169 devices can be powered from a single power supply and their input voltages can exceed the power supply voltage. The INA139 and INA169 devices are ideal for measuring small differential voltages, such as those generated across a shunt resistor in the presence of large, common-mode voltages. See *Functional Block Diagram*, which illustrates the functional components within both the INA139 and INA169 devices.

### 7.2 Functional Block Diagram



#### 7.3 Feature Description

#### 7.3.1 Output Voltage Range

The output of the INA139 is a current, which is converted to a voltage by the load resistor, R<sub>L</sub>. The output current remains accurate within the *compliance voltage range* of the output circuitry. The shunt voltage and the input common-mode and power-supply voltages limit the maximum possible output swing. The maximum output voltage compliance is limited by the lower of Equation 1 and Equation 2.

$$V_{\text{out max}} = (V+) - 0.7 \ V - (V_{\text{IN+}} - V_{\text{IN-}}) \tag{1}$$

or

$$V_{\text{out max}} = V_{\text{IN-}} - 0.5 \text{ V}$$
 (2)

(whichever is lower)

#### 7.3.2 Bandwidth

Measurement bandwidth is affected by the value of the load resistor,  $R_L$ . High gain produced by high values of  $R_L$  will yield a narrower measurement bandwidth (see *Typical Characteristics*). For widest possible bandwidth, keep the capacitive load on the output to a minimum. Reduction in bandwidth due to capacitive load is shown in the *Typical Characteristics*.



### **Feature Description (continued)**

If bandwidth limiting (filtering) is desired, a capacitor can be added to the output (see Figure 12). This will not cause instability.

### 7.4 Device Functional Modes

For proper operation the INA139 and INA169 devices must operate within their specified limits. Operating either device outside of their specified power supply voltage range or their specified common-mode range will result in unexpected behavior and is not recommended. Additionally operating the output beyond their specified limits with respect to power supply voltage and input common-mode voltage will also produce unexpected results. See *Electrical Characteristics* for the device specifications.



# 8 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

#### 8.1.1 Operation

Figure 9 illustrates the basic circuit diagram for both the INA139 and INA169. Load current  $I_S$  is drawn from supply  $V_S$  through shunt resistor  $R_S$ . The voltage drop in shunt resistor  $V_S$  is forced across  $R_{G1}$  by the internal operational amplifier, causing current to flow into the collector of Q1. The external resistor  $R_L$  converts the output current to a voltage,  $V_{OUT}$ , at the OUT pin.

The transfer function for the INA139 is given by Equation 3:

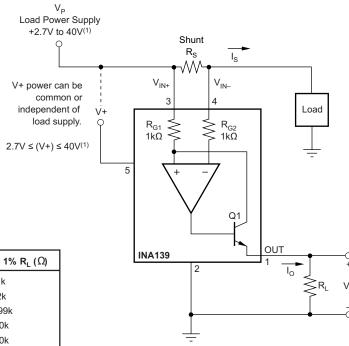
$$I_{O} = g_{m}(V_{IN+} - V_{IN-})$$
(3)

where  $g_m = 1000 \mu A/V$ .

In the circuit of Figure 9, the input voltage,  $(V_{IN+} - V_{IN-})$ , is equal to  $I_S \times R_S$  and the output voltage,  $V_{OUT}$ , is equal to  $I_O \times R_L$ . The transconductance,  $g_m$ , of the INA139 is 1000  $\mu$ A/V. The complete transfer function for the current measurement amplifier in this application is given by Equation 4:

$$V_{OLT} = (I_S) (R_S) (1000 \,\mu\text{A/V}) (R_I) \tag{4}$$

The maximum differential input voltage for accurate measurements is 0.5 V, which produces a 500-µA output current. A differential input voltage of up to 2 V will not cause damage. Differential measurements (pins 3 and 4) must be unipolar with a more-positive voltage applied to pin 3. If a more-negative voltage is applied to pin 3, the output current, I<sub>O</sub>, is zero, but it will not cause damage.



**VOLTAGE GAIN** EXACT  $R_L(\Omega)$ NEAREST 1% R<sub>I</sub> (Ω) 1k 2 2k 2k 5 5k 4 99k 10 10k 10k 20 20k 20k 50 50k 49k 100 100k

NOTE: (1) Maximum V<sub>P</sub> and V+ voltage is 60V with the INA169.

Figure 9. Basic Circuit Connections



#### 8.2 Typical Applications

The INA139 is designed for current shunt measurement circuits, as shown in Figure 9, but its basic function is useful in a wide range of circuitry. A creative engineer will find many unforeseen uses in measurement and level shifting circuits. A few ideas are illustrated in Figure 14 through Figure 18.

#### 8.2.1 Buffering Output to Drive an ADC

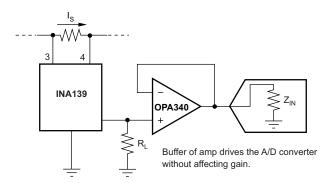


Figure 10. Buffering Output to Drive the A/D Converter

#### 8.2.1.1 Design Requirements

Digitize the output of the INA139 or INA169 devices using a 1-MSPS analog-to-digital converter (ADC).

#### 8.2.1.2 Detailed Design Procedure

#### 8.2.1.2.1 Selecting R<sub>S</sub> and R<sub>I</sub>

In Figure 9 the value chosen for the shunt resistor,  $R_S$ , depends on the application and is a compromise between small-signal accuracy and maximum permissible voltage loss in the measurement line. High values of  $R_S$  provide better accuracy at lower currents by minimizing the effects of offset, while low values of  $R_S$  minimize voltage loss in the supply line. For most applications, best performance is attained with an  $R_S$  value that provides a full-scale shunt voltage of 50 mV to 100 mV; maximum input voltage for accurate measurements is 500 mV.

 $R_L$  is chosen to provide the desired full-scale output voltage. The output impedance of the INA139 and INA169 OUT terminal is very high, which permits using values of  $R_L$  up to 100 k $\Omega$  with excellent accuracy. The input impedance of any additional circuitry at the output must be much higher than the value of  $R_L$  to avoid degrading accuracy.

Some Analog-to-Digital converters (ADC) have input impedances that will significantly affect measurement gain. The input impedance of the ADC can be included as part of the effective  $R_L$  if its input can be modeled as a resistor to ground. Alternatively, an operational amplifier can be used to buffer the ADC input, as shown in Figure 10. The INA139 and INA169 are current output devices, and as such have an inherently large output impedance. The output currents from the amplifier are converted to an output voltage through the load resistor,  $R_L$ , connected from the amplifier output to ground. The ratio of the load resistor value to that of the internal resistor value determines the voltage gain of the system.

In many applications digitizing the output of the INA139 or INA169 devices is required. This is accomplished by connecting the output of the amplifier to an ADC. It is very common for an ADC to have a dynamic input impedance. If the INA139 or INA169 output is connected directly to an ADC input, the input impedance of the ADC is effectively connected in parallel with the gain setting resistor R<sub>L</sub>. This parallel impedance combination will affect the gain of the system and the impact on the gain is difficult to estimate accurately. A simple solution that eliminates the paralleling of impedances, simplifying the gain of the circuit is to place a buffer amplifier, such as the OPA340, between the output of the INA139 or INA169 devices and the input to the ADC.

Figure 10 illustrates this concept. A low pass filter can be placed between the OPA340 output and the input to the ADC. The filter capacitor is required to provide any instantaneous demand for current required by the input stage of the ADC. The filter resistor is required to isolate the OPA340 output from the filter capacitor to maintain circuit stability. The values for the filter components will vary according to the operational amplifier used for the buffer and the particular ADC selected. More information can be found regarding the design of the low pass filter in the TI Precision Design 16-bit 1-MSPS Data Acquisition Reference Design for Single-Ended Multiplexed Applications, TIPD173.

Figure 11 shows the expected results when driving an analog-to-digital converter at 1 MSPS with and without buffering the INA139 or INA169 output. Without the buffer, the high impedance of the INA139 or INA169 will react with the input capacitance and sample and hold (S/H) capacitance of the analog-to-digital converter and will not allow the S/H to reach the correct final value before it is reset and the next conversion starts. Adding the buffer amplifier significantly reduces the output impedance driving the S/H and allows for higher conversion rates than can be achieved without adding the buffer.

### 8.2.1.3 Application Curve

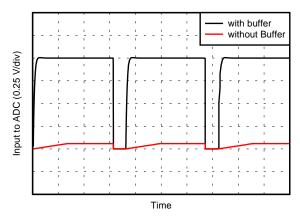


Figure 11. Driving an ADC With and Without a Buffer

#### 8.2.2 Output Filter

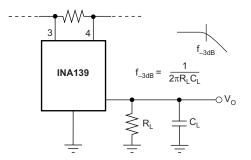


Figure 12. Output Filter

#### 8.2.2.1 Design Requirements

Filter the output of the INA139 or INA169 devices.

### 8.2.2.2 Detailed Design Procedure

A low-pass filter can be formed at the output of the INA139 or INA169 devices simply by placing a capacitor of the desired value in parallel with the load resistor. First determine the value of the load resistor needed to achieve the desired gain. See the table in Figure 9. Next, determine the capacitor value that will result in the desired cutoff frequency according to the equation shown in Figure 12. Figure 13 illustrates various combinations of gain settings (determined by R<sub>I</sub>) and filter capacitors.



#### 8.2.2.3 Application Curve

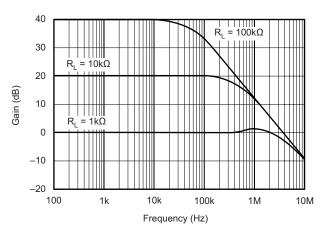


Figure 13. Gain vs Frequency

#### 8.2.3 Offsetting the Output Voltage

For many applications using only a single power supply it may be required to level shift the output voltage away from ground when there is no load current flowing in the shunt resistor. Level shifting the output of the INA139 or INA169 devices is easily accomplished by one of two simple methods shown in Figure 14. The method on the left hand side of Figure 14 illustrates a simple voltage divider method. This method is useful for applications that require the output of the INA138 or INA168 devices to remain centered with respect to the power supply at zero load current through the shunt resistor. Using this method the gain is determine by the parallel combination of  $R_1$  and  $R_2$  while the output offset is determined by the voltage divider ratio  $R_1$  and  $R_2$ . For applications that may require a fixed value of output offset, independent of the power supply voltage, the current source method shown on the right-hand side of Figure 14 is recommended. With this method a REF200 constant current source is used to generate a constant output offset. Using his method the gain is determined by  $R_L$  and the offset is determined by the product of the value of the current source and  $R_1$ .

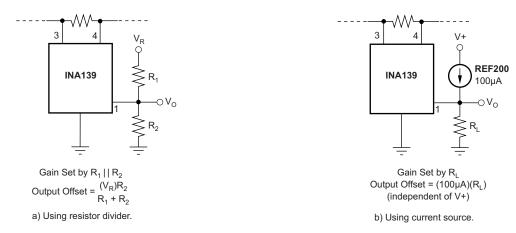


Figure 14. Offsetting the Output Voltage



#### 8.2.4 Bipolar Current Measurement

The INA139 or INA169 devices can be configured as shown in Figure 15 in applications where measuring current bi-directionally is required. Two INA devices are required connecting their inputs across the shunt resistor as shown in Figure 15. A comparator, such as the TLV3201, is used to detect the polarity of the load current. The magnitude of the load current is monitored across the resistor connected between ground and the connection labeled Output. In this example the  $20-k\Omega$  resistor results in a gain of 20~V/V. The  $10-k\Omega$  resistors connected in series with the INA139 or INA169 output current are used to develop a voltage across the comparator inputs. Two diodes are required to prevent current flow into the INA139 or INA169 output, as only one device at a time is providing current to the Output connection of the circuit. The circuit functionality is illustrated in Figure 16.

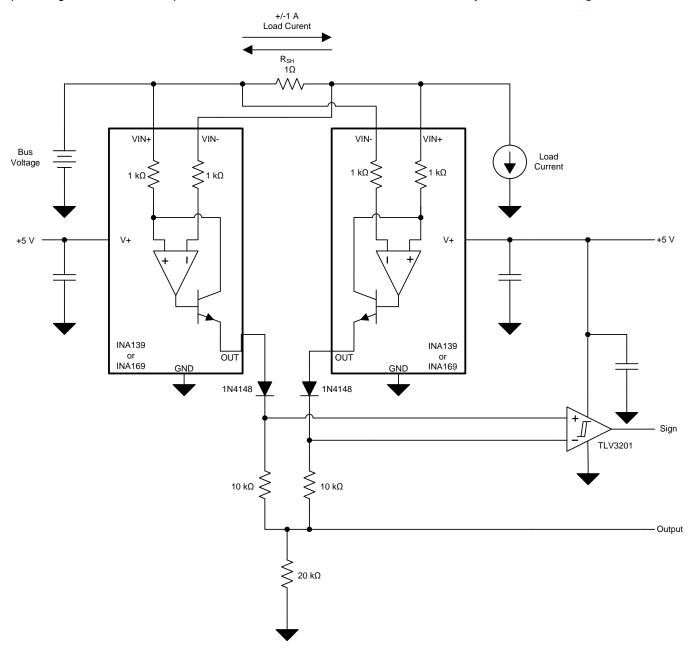


Figure 15. Bipolar Current Measurement



#### 8.2.4.1 Application Curve

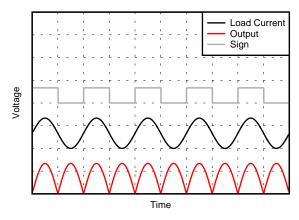


Figure 16. Bipolar Current Measurement Results (Arbitrary Scale)

### 8.2.5 Bipolar Current Measurement Using a Differential Input of the A/D Converter

The INA139 or INA169 devices can be used with an ADC such as the ADS7870 programmed for differential mode operation. Figure 17 illustrates this configuration. In this configuration, the use of two INAs allows for bidirectional current measurement. Depending upon the polarity of the current, one of the INAs will provide an output voltage while the other output is zero. In this way the ADC will read the polarity of current directly, without the need for additional circuitry.

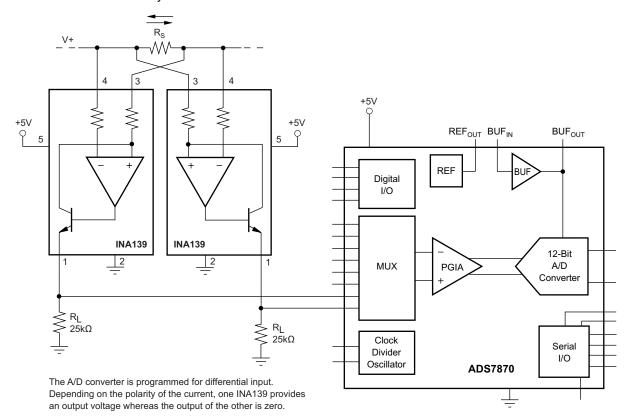


Figure 17. Bipolar Current Measurement Using a Differential Input of the A/D Converter



### 8.2.6 Multiplexed Measurement Using Logic Signal for Power

Multiple loads can be measured as illustrated in Figure 18. In this configuration each INA139 or INA169 device is powered by the Digital I/O from the ADS7870. Multiplexing is achieved by switching on or off each the desired I/O

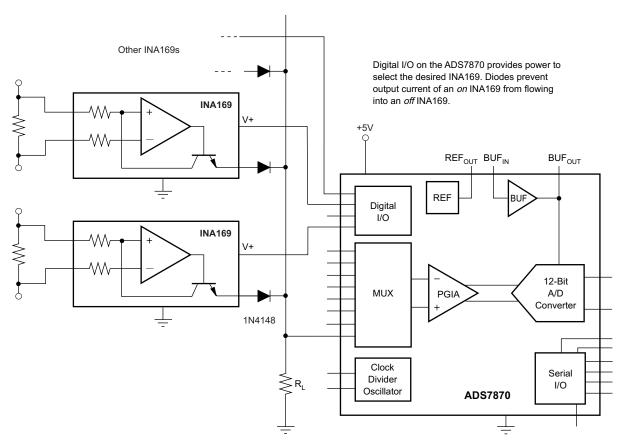


Figure 18. Multiplexed Measurement Using Logic Signal for Power

### 9 Power Supply Recommendations

The input circuitry of the INA139 can accurately measure beyond its power-supply voltage, V+. For example, the V+ power supply can be 5 V, whereas the load power supply voltage is up to 40 V (or 60 V with the INA169). However, the output voltage range of the OUT terminal is limited by the lesser of the two voltages (see *Output Voltage Range*). TI recommends placing a 0.1-µF capacitor near the V+ pin on the INA139 or INA169. Additional capacitance may be required for applications with noisy supply voltages.



### 10 Layout

### 10.1 Layout Guidelines

Figure 19 shows the basic connection of the INA139. The input pins,  $V_{IN+}$  and  $V_{IN-}$ , must be connected as closely as possible to the shunt resistor to minimize any resistance in series with the shunt resistance. The output resistor,  $R_L$ , is shown connected between pin 1 and ground. Best accuracy is achieved with the output voltage measured directly across  $R_L$ . This is especially important in high-current systems where load current could flow in the ground connections, affecting the measurement accuracy.

No power-supply bypass capacitors are required for stability of the INA139. However, applications with noisy or high-impedance power supplies may require decoupling capacitors to reject power-supply noise; connect the bypass capacitors close to the device pins.

### 10.2 Layout Example

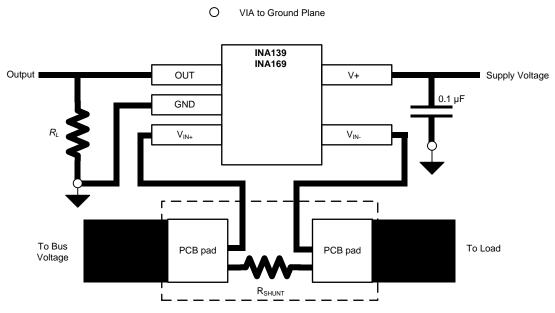


Figure 19. Typical Layout Example



### 11 器件和文档支持

### 11.1 相关链接

下面的表格列出了快速访问链接。范围包括技术文档、支持和社区资源、工具和软件,以及样片或购买的快速访问。

表 1. 相关链接

器件	器件 产品文件夹		技术文档	工具与软件	支持与社区		
INA139	请单击此处	请单击此处	请单击此处	请单击此处	请单击此处		
INA169	请单击此处	请单击此处	请单击此处	请单击此处	请单击此处		

### 11.2 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 11.3 商标

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#### 11.4 静电放电警告



这些装置包含有限的内置 ESD 保护。 存储或装卸时,应将导线一起截短或将装置放置于导电泡棉中,以防止 MOS 门极遭受静电损伤。

### 11.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 12 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本,请查阅左侧的导航栏。

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#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
INA139NA/250	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	E39
INA139NA/250.A	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	E39
INA139NA/3K	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	E39
INA139NA/3K.A	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	E39
INA169NA/250	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	A69
INA169NA/250.A	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	A69
INA169NA/3K	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	A69
INA169NA/3K.A	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	A69

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# PACKAGE OPTION ADDENDUM

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF INA139, INA169:

• Automotive : INA139-Q1, INA169-Q1

NOTE: Qualified Version Definitions:

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

# PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





_		
		Dimension designed to accommodate the component width
		Dimension designed to accommodate the component length
		Dimension designed to accommodate the component thickness
	W	Overall width of the carrier tape
ſ	P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
INA139NA/250	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
INA139NA/3K	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
INA169NA/250	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
INA169NA/3K	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3

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#### \*All dimensions are nominal

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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
INA139NA/250	SOT-23	DBV	5	250	180.0	180.0	18.0
INA139NA/3K	SOT-23	DBV	5	3000	180.0	180.0	18.0
INA169NA/250	SOT-23	DBV	5	250	180.0	180.0	18.0
INA169NA/3K	SOT-23	DBV	5	3000	180.0	180.0	18.0



SMALL OUTLINE TRANSISTOR



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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